



FOR IMMEDIATE RELEASE

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SHENMAO America Appoints New Rep to Expand Midwestern Support

SAN JOSE, CA — December 2018 — SHENMAO America, Inc. is pleased to announce the appointment of MIDwest TEKologies as its representative in the Midwest region. The manufacturers' representative will provide sales and customer support for SHENMAO in MN, ND, SD and IA.

"We are excited to partner with SHENMAO America in offering their innovative line of products," notes Marshall "Lucky" Balin, President and CEO of MIDwest TEKologies. "As leaders in the semiconductor industry, we have the knowledge and experience in assisting contract manufacturers and OEMs to make the correct decisions regarding solder products, including paste, bar, wire, sphere preform and cleaner.

An experienced manufacturers' representative specializing in electronic manufacturing equipment; MIDwest TEKologies works with companies in the automotive, industrial, medical electronics, military, aerospace and telecommunications industries. Active in SMTA, the company is strategically headquartered in central Minnesota to address and service the needs of customers in the Midwest. MIDwest TEKologies can be contacted to discuss products at 763-261-2071 or sales@MidTek.net.

SHENMAO has successfully been approved by many international well-known electronic manufacturers. The company strives to offer the best quality without compromising cost and time-to-market while providing maximum value to all customers. SHENMAO America, Inc. blends SMT solder paste at its facility in San Jose, CA for distribution in North America.

For more information, please visit www.shenmao.com.

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About SHENMAO

SHENMAO is dedicated to the production of solder products including Water Soluble and No-clean Solder Paste, Laser Solder Paste, Solder Preforms, Cored Solder Wire, Wave Solder Bar Alloys, Wave Soldering Fluxes, Extremely Pure Solder Powder up to Type 8, BGA and Micro

BGA Solder Sphere, Wafer Level Packaging Solder Paste and Fluxes, LED Die Attach Paste, High Performance Liquid Fluxes, Solder Preform, Solar Ribbon, Plating Anode used in PCB Fabrication, Assembly and Semiconductor Packaging Processes.